
























# Board Stack Report

Stack Up			Layer Stack			
Layer	Board Layer Stack	Flex	Name	Material	Thickness	Constant
1			Top Paste			
2			Top Overlay			
3			Top Solder	Solder Resist	0.40mil	3.5
4			Top Layer	Copper	1.40mil	
5			Dielectric 1	PP-017	5.10mil	4.3
6			Layer 1	Copper	1.38mil	
7			Dielectric 2.1	PP-017	5.10mil	4.3
8			Dielectric 2.2	Core-025	8.00mil	4.6
9			Layer 2	Copper	1.38mil	
10			Dielectric 3.1	PP-017	5.10mil	4.3
11			Dielectric 3.2	PP-017	5.10mil	4.3
12			Layer 3	Copper	1.38mil	
13			Dielectric 4	Core-025	8.00mil	4.6
14			Layer 4	Copper	1.38mil	
15			Dielectric 5.2	PP-017	5.10mil	4.3
16			Dielectric 5.1	PP-017	5.10mil	4.3
17			Layer 5	Copper	1.38mil	
18			Dielectric 6.2	Core-025	8.00mil	4.6
19			Dielectric 6.1	PP-017	5.10mil	4.3
20			Layer 6	Copper	1.38mil	
21			Dielectric 7	PP-017	5.10mil	4.3
22			Bottom Layer	Copper	1.40mil	
23			Bottom Solder	Solder Resist	0.40mil	3.5
24			Bottom Overlay			
25			Bottom Paste			
	Height : 66.47mil	Height : 36.67mil				